ITEQ Corporation

2020 Fourth Quarter Earnings Result

ITEQ

INNOVATION. TEAMWORK. EXCELLENCE. QUALITY

Disclaimer Statement



- This presentation and release contain "forward-looking statements" which may include projections
 of future results of operations, financial condition or business prospects based on our own
 information and other sources.
- Our actual results of operations, financial condition or business prospects may differ from those expressed or implied in these forward-looking statements for a variety of reasons, including but not limited to market demand, price fluctuations, competition, international economic conditions, supply chain issues, exchange rate fluctuations and other risks and factors beyond our control.
- The forward-looking statements in this release reflect the current belief of ITEQ as of the date of this release. ITEQ undertakes no obligation to update these forward-looking statements for events or circumstances that occur subsequent to such date.

Company Overview

◆ Establishment: April 10th, 1997

◆ Headquarter: HsinChu, Taiwan

◆ Capital: NTD\$3,330M

◆ Employees: Over 3,000

Chairman: Dennis Chen

◆ CEO: Audrey Tsai

◆ Main Product: Copper Clad Laminate & Prepreg

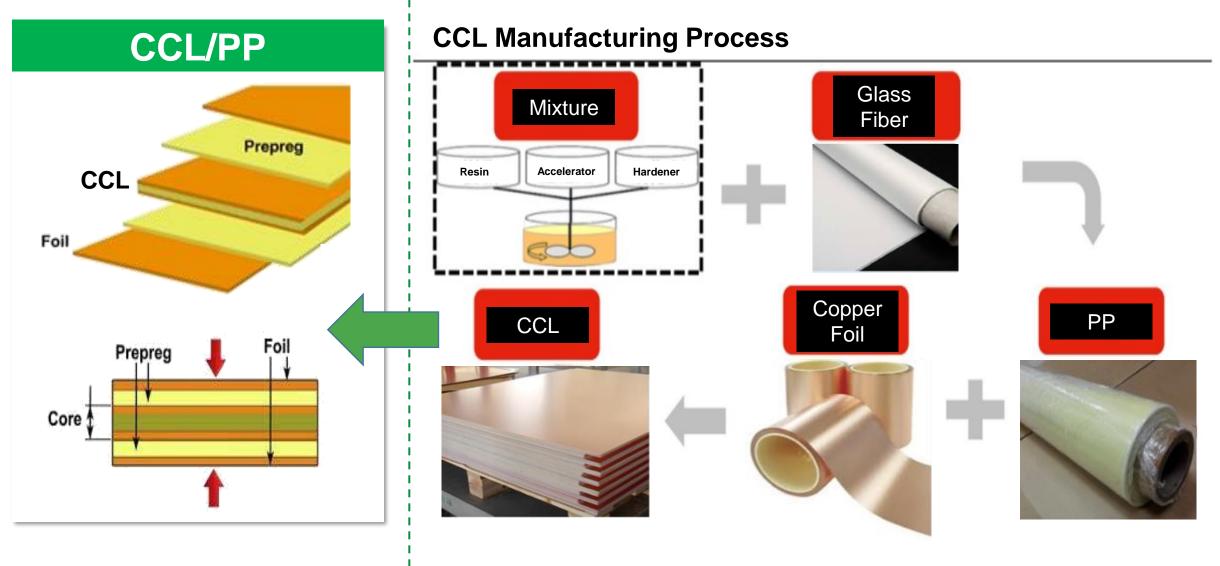
Flexible CCL

Masslam service



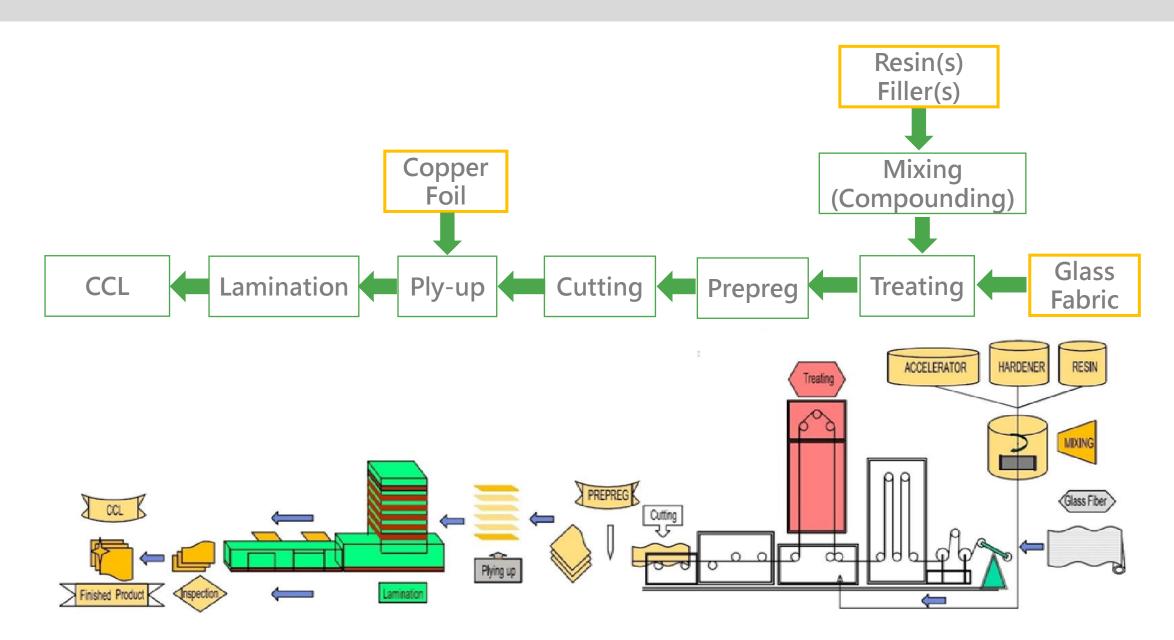
CCL & PP Composite Structure





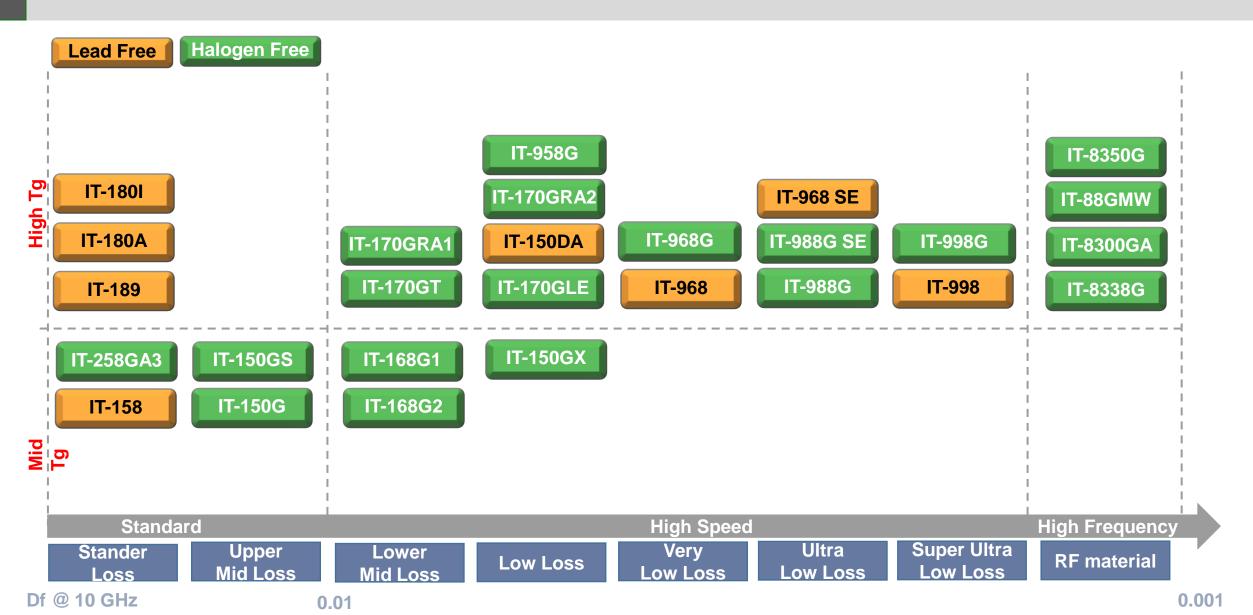
CCL & PP Manufacturing Flow





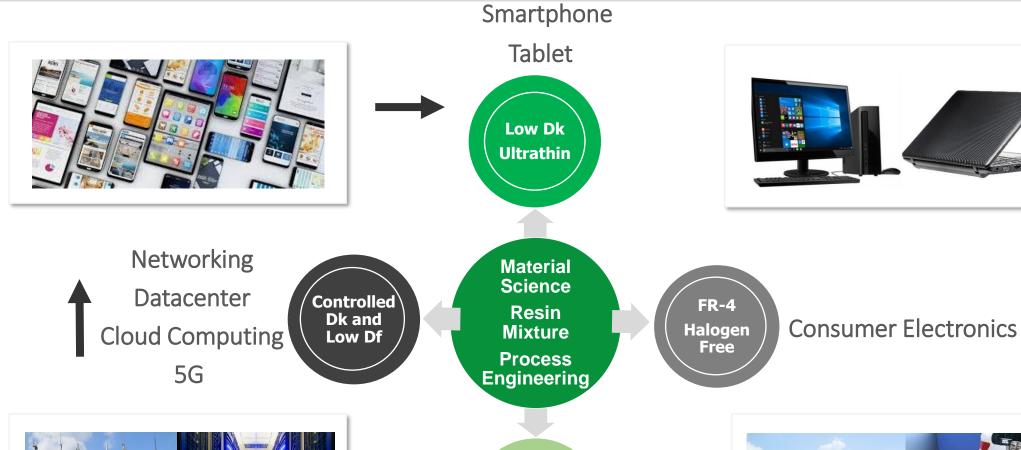
Product Roadmap





Core Technology





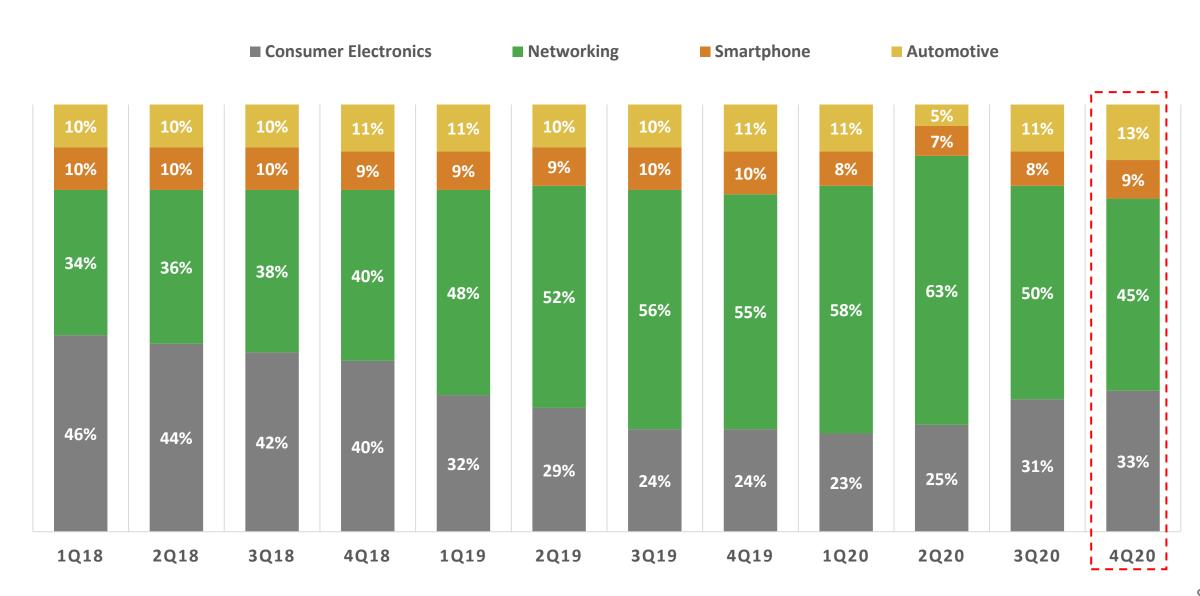






1Q18~4Q20 Product Mix

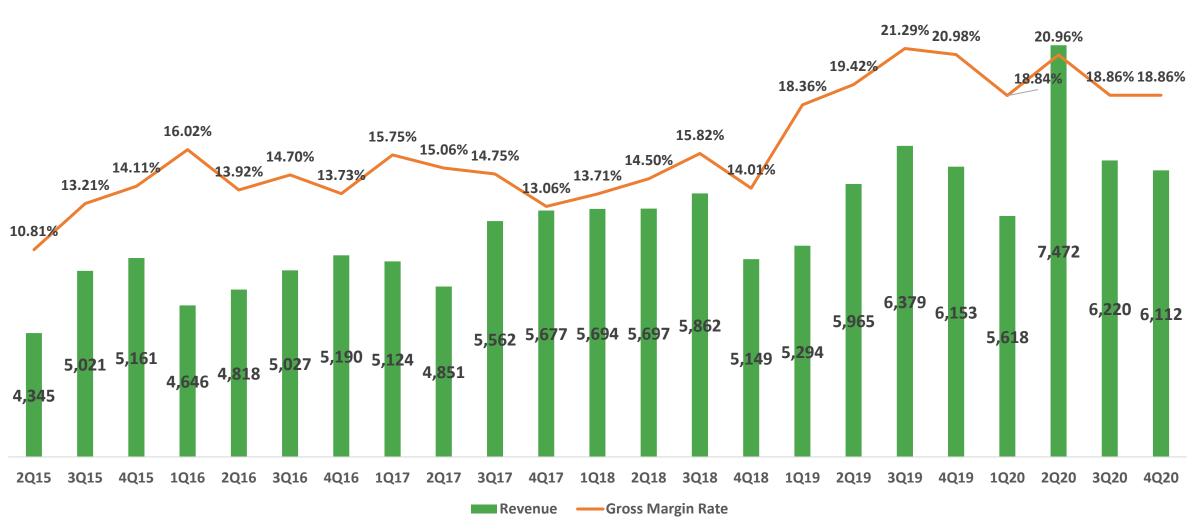




Revenue & Gross Margin Rate

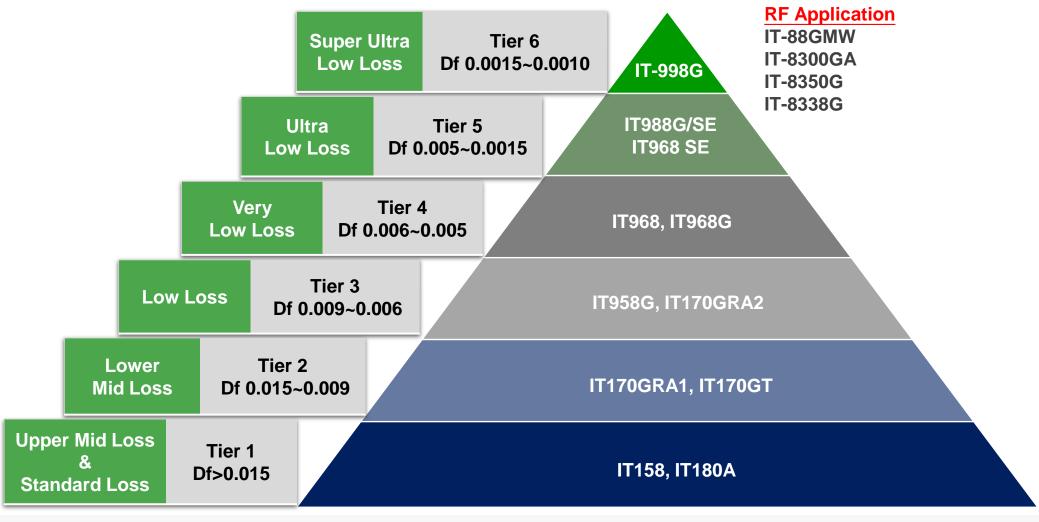


(Million \$NTD)



Well-Expanded Product Line





- The need for 5G commercialization and server upgrade will expedite the growth of high speed / frequency demand
- ITEQ's market share in high speed / frequency material to uplift robustly

4Q20&FY20 Income Statement

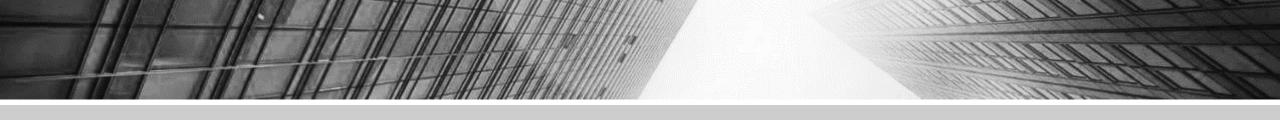


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4Q20	3Q20	4Q19	QoQ	YoY	2020	2019	YoY
6,112	6,220	6,153	-2%	-1%	25,422	23,791	7%
1,153	1,173	1,291	-2%	-11%	4,951	4,780	4%
327	454	442	-28%	-26%	1,732	1,676	3%
826	719	849	15%	-3%	3,219	3,104	4%
164	97	13			176	(9)	
990	816	862	21%	15%	3,395	3,095	10%
212	172	198			729	631	
778	644	664	21%	17%	2,666	2,464	8%
2.34	1.94	2.19	21%	7%	8.19	8.13	1%
1					 	 	
18.9%	18.9%	21.0%			19.5%	20.1%	
5.4%	7.3%	7.2%			6.8%	7.0%	
13.5%	11.6%	13.8%			12.7%	13.0%	
21.4%	21.1%	23.0%			21.5%	20.4%	
12.7%	10.4%	10.8%			10.5%	10.4%	
	6,112 1,153 327 826 164 990 212 778 2.34 18.9% 5.4% 13.5% 21.4%	6,1126,2201,1531,173327454826719164979908162121727786442.341.9418.9%7.3%13.5%11.6%21.4%21.1%	6,112 6,220 6,153 1,153 1,173 1,291 327 454 442 826 719 849 164 97 13 990 816 862 212 172 198 778 644 664 2.34 1.94 2.19 18.9% 21.0% 5.4% 7.3% 7.2% 13.5% 11.6% 13.8% 21.4% 21.1% 23.0%	6,112 6,220 6,153 -2% 1,153 1,173 1,291 -2% 327 454 442 -28% 826 719 849 15% 164 97 13 990 816 862 21% 212 172 198 778 644 664 21% 2.34 1.94 2.19 21% 5.4% 7.3% 7.2% 13.5% 11.6% 13.8% 21.4% 21.1% 23.0%	6,112 6,220 6,153 -2% -1% 1,153 1,173 1,291 -2% -11% 327 454 442 -28% -26% 826 719 849 15% -3% 164 97 13 15% -3% 990 816 862 21% 15% 212 172 198 778 644 664 21% 17% 2.34 1.94 2.19 21% 7% 18.9% 18.9% 21.0% 5.4% 7.3% 7.2% 13.5% 11.6% 13.8% 21.4% 21.1% 23.0%	6,112 6,220 6,153 -2% -1% 25,422 1,153 1,173 1,291 -2% -11% 4,951 327 454 442 -28% -26% 1,732 826 719 849 15% -3% 3,219 164 97 13 176 15% 3,395 212 172 198 729 778 644 664 21% 17% 2,666 2.34 1.94 2.19 21% 7% 8.19 18.9% 18.9% 21.0% 19.5% 5.4% 7.3% 7.2% 6.8% 13.5% 11.6% 13.8% 12.7% 21.4% 21.1% 23.0% 21.5%	6,112 6,220 6,153 -2% -1% 25,422 23,791 1,153 1,173 1,291 -2% -11% 4,951 4,780 327 454 442 -28% -26% 1,732 1,676 826 719 849 15% -3% 3,219 3,104 164 97 13 176 (9) 990 816 862 21% 15% 3,395 3,095 212 172 198 729 631 778 644 664 21% 17% 2,666 2,464 2.34 1.94 2.19 21% 7% 8.19 8.13 18.9% 7.3% 7.2% 6.8% 7.0% 13.5% 11.6% 13.8% 12.7% 13.0% 21.4% 21.1% 23.0% 21.5% 20.4%

4Q20 Balance Sheet



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NTD \$Million	4Q20	3Q20	4Q19
Total Assets	25,684	25,953	23,480
Cash	3,287	3,625	3,538
Marketable Securities	6	6	93
NR / AR	10,813	11,200	10,599
Inventories	3,243	3,330	2,664
Fixed Assets	6,484	5,896	4,594
Total Liabilities	12,291	13,527	14,555
Short-term Debt	2,370	2,331	3,882
NP/AP	4,858	6,328	6,384
Long-term Debt	1,640	1,640	1,288
Total Equity	13,394	12,426	8,926
Key Financial Index			
Days Sales Outstanding	154	156	149
Days Sales of Inventory	55	56	43
Days Payable Outstanding	100	111	102
ROE (%)	23.90	23.90	29.12
ROA (%)	11.09	10.57	11.95
Debt ratio (%)	47.85	52.12	61.99
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Market Trend & Growth Drivers





Hunger for High Speed Transmission

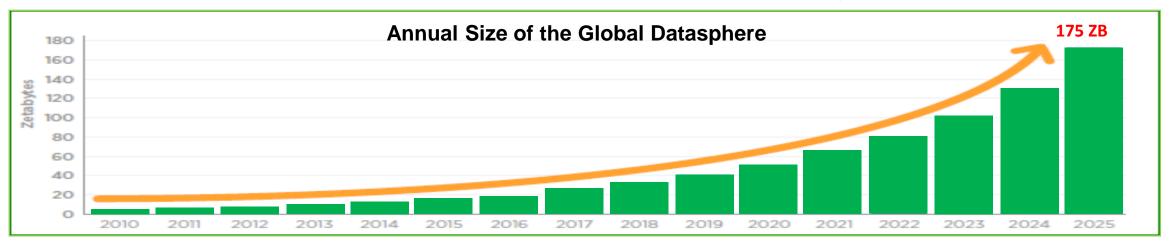


Rapid expansion of Global Datasphere

- Core (traditional and cloud datacenters)
- Edge (enterprise-hardened infrastructure such as, server rooms, servers in the field, cell towers, and smaller datacenters etc.)
- Endpoint (PCs, smartphones, and IoT devices)

Fast growing Global IP traffic

- UHD video streaming and internet gaming
- Connected home, work, health and car
- Big data and Al applications
- Cloud computing and cloud storage
- Virtual Reality (VR) and Augmented Reality (AR)



(Source: Data Age 2025, sponsored by Seagate with data from IDC Global DataSphere, May 2020)

 Rapid growth of global data traffic stimulates equipment upgrade to meet the need of low latency, high reliable and high speed computing

5G Network Infrastructure & Opportunities



Core (Telecom) + Transport Network:

- Including data center, Edge computing, OTN
- High efficient computing and massive data traffic

High Speed Material

Distributed + Centralized Unit (DU+CU)

- Including Macro Cell, Micro Cell to Small Cell
- Low latency and high speed requirements

High Speed Material

Active Antenna Unit (AAU)

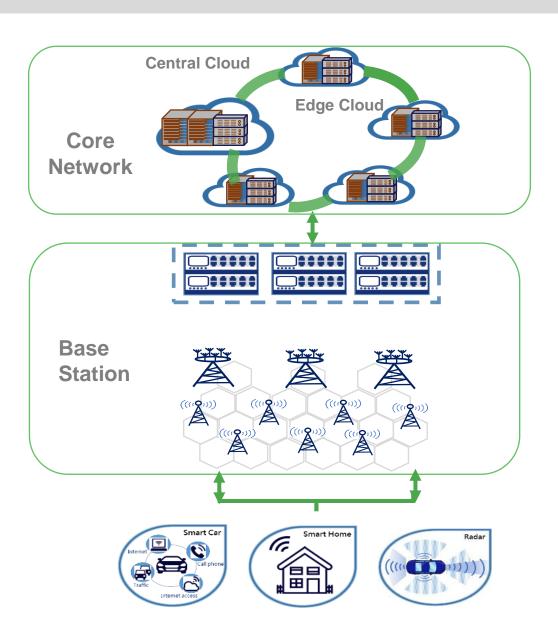
- Including Antenna, PA, TRX Network
- Multi layer design for complex functionality

High Speed Material

High Frequency Material

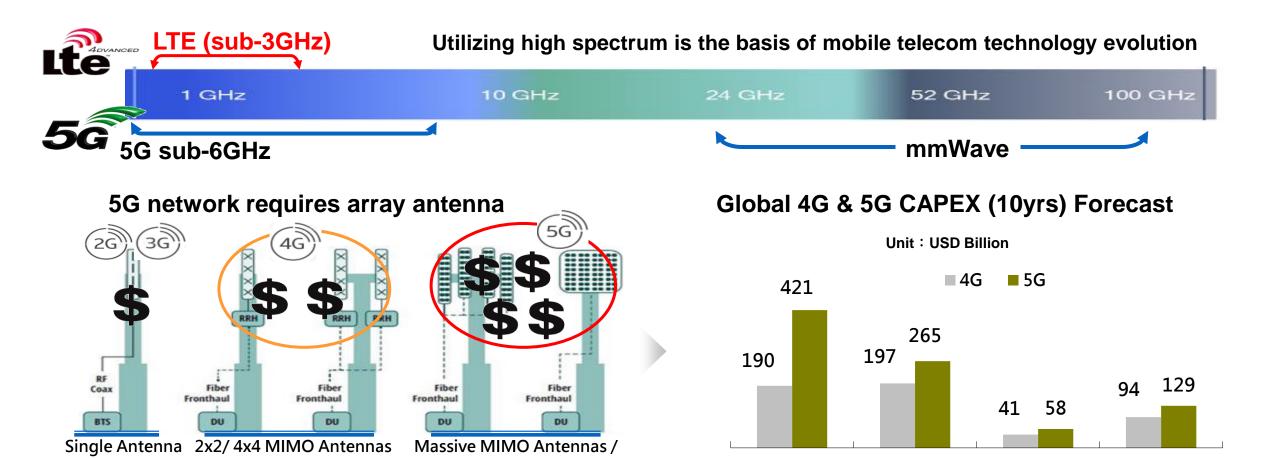
loT(Internet of Things)

High Speed Material



Sustainable Growth Momentum (Telecom)





CHINA

USA

KOREA

- Source: Morgan Stanley · 2019/2; DIGITIMES Research · 2020/8
- High Spectrum 5G Network: Need base station equipment MP/upgrade to drive the demand of high speed/frequency material to grow

Beamforming

Design Complexity of PCB: Increase area and layer counts for PCB to bring up the unit of demand for CCL

JAPAN

Sustainable Growth Momentum (Datacom)





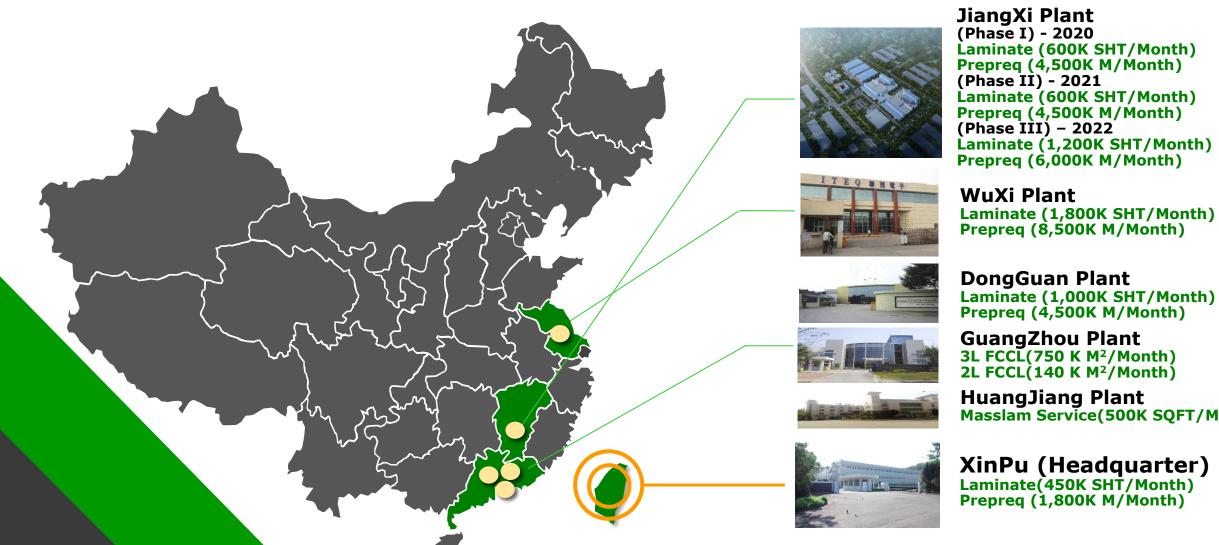


Source: DIGITIMES Research . 2020/9

- Increase of Datacenter Equipment Shipment: Demand of high speed material to grow correlatively
- Hardware Equipment Upgrade: Corresponding CCL material to upgrade

Manufacturing Site & Capacity





Laminate (600K SHT/Month) Prepreq (4,500K M/Month) Laminate (600K SHT/Month)

Prepreq (4,500K M/Month)

Laminate (1,200K SHT/Month) Prepreg (6,000K M/Month)

Laminate (1,800K SHT/Month) Prepreq (8,500K M/Month)

Prepreq (4,500K M/Month)

3L FCCL(750 K M²/Month)

Masslam Service(500K SQFT/Month)

XinPu (Headquarter)

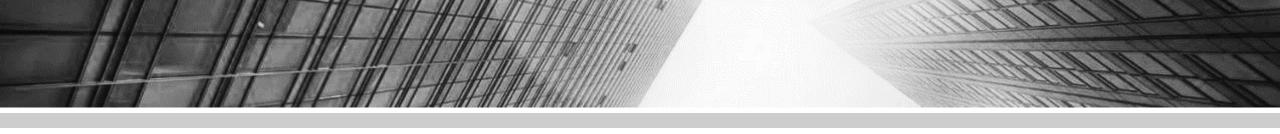
Laminate(450K SHT/Month) Prepreq (1,800K M/Month)

2014 – 2020 Dividend Policy



Year	EPS(NT\$)	Dividend(NT\$)	Cash Dividend(NT\$)	Pay-out Ratio(%)
2014	1.62	1.2	1.2	74%
2015	1.92	1.6	1.6	83%
2016	3.13	2.5	2.5	80%
2017	4.11	3.1	3.1	75%
2018	5.86	3.8	3.8	65%
2019	8.13	5.0	5.0	62%
2020	8.19	5.0	5.0	61%

^{*}New shares issuance of 30 million common shares concluded in March 31st 2020; current total outstanding common share: 333 million



ITEQ & MGC Joint Venture Project

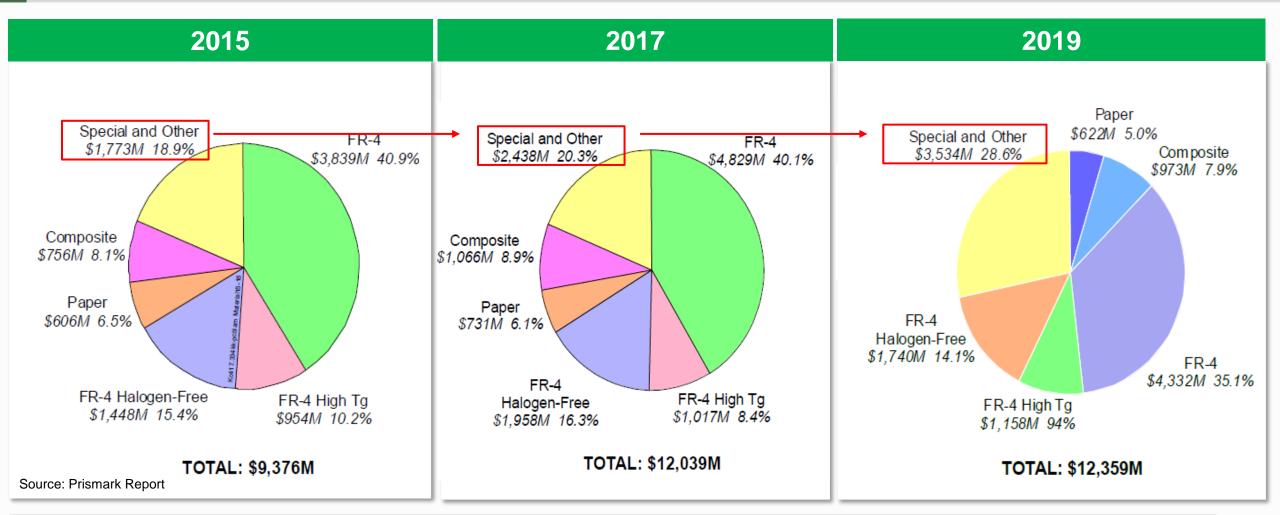




Increase of Special CCL Production Value



Global CCL Production Value (\$USD)



- High Speed Transmission: Global special laminates production value increased to \$3,534M in 2019 from \$1,773M in 2015
- Leadership of High Speed/Frequency Technology: ITEQ to set footprint in IC substrate materials adopted in the semiconductor packaging applications

ITEQ x MGC JV – IC Substrate Material



MGC

IC Packaging Laminate

MGC & ITEQ

IC Substrate Material **ITEQ**

High
Speed/Frequency CCL



BT Substrate

- Logic IC (Consumer Electronic, Smartphone, GPU, CPU)
- Memory IC (DRAM, NAND Flash)

